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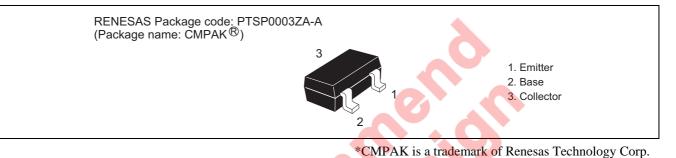
Silicon PNP Epitaxial

REJ03G0644-0100 (Previous ADE-208-1477) Rev.1.00 Aug.10.2005

### Features

Low frequency amplifier

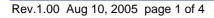
### Outline



# **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	-55	V
Collector to emitter voltage	V <sub>CEO</sub>	-55	V
Emitter to base voltage	V <sub>EBO</sub>	-5	V
Collector current	lc	-100	mA
Collector power dissipation	Pc*	150	mW
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	۵°

\*Value on the glass epoxy board (10 mm x 10 mm x 0.7 mm)





# **Electrical Characteristics**

						$(1a = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V <sub>(BR)CBO</sub>	-55	—		V	$I_{C} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	V <sub>(BR)CEO</sub>	-55	—		V	$I_{C} = -1 \text{ mA}, \text{ R}_{BE} = \infty$
Emitter to base breakdown voltage	V <sub>(BR)EBO</sub>	-5	—	_	V	$I_E = -10 \ \mu A, \ I_C = 0$
Collector cutoff current	I <sub>СВО</sub>	—	—	-0.5	μA	$V_{CB} = -30 \text{ V}, I_E = 0$
Emitter cutoff current	I <sub>EBO</sub>	—	—	-0.5	μA	$V_{EB} = -2 V, I_C = 0$
DC current transfer ratio	h <sub>FE</sub> * <sup>1</sup>	160	—	500	_	$V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	—	—	-0.5	V	$I_{\rm C} = -10$ mA, $I_{\rm B} = -1$ mA
Base to emitter voltage	V <sub>BE</sub>	_	_	-0.75	V	$V_{CE} = -12 \text{ V}, I_C = -2 \text{ mA}$

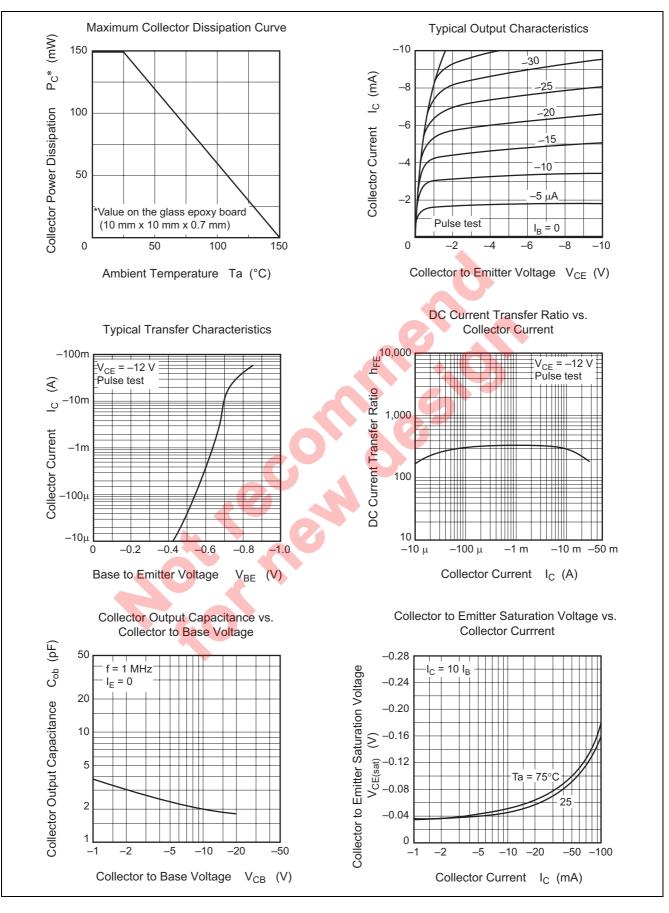
 $(\mathbf{T}_{0} - 25^{\circ}\mathbf{C})$ 

Notes: 1. The 2SA2081 is grouped by  $h_{FE}$  as follows.

Grade	С	D
Mark	CC	CD
h <sub>FE</sub>	160 to 320	250 to 500

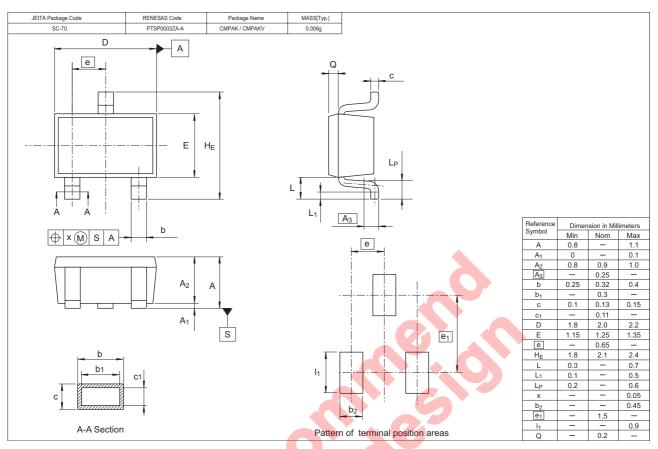


### **Main Characteristics**





## **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
2SA2081CCTL-E	3000	o 178 mm Reel, 8 mm Emboss Taping
2SA2081CDTL-E		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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### Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

### Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510